- Radiant sensitive area (in mm²): 4.4
- High photo sensitivity
- · High radiant sensitivity
- · Suitable for visible and near infrared radiation
- Angle of half sensitivity: $\phi = \pm 65^{\circ}$
- Floor life: 168 h, MSL 3, acc. J-STD-020
- · Lead (Pb)-free reflow soldering
- · Compliant to RoHS Directive 2002/95/EC and in accordance to WEEE 2002/96/EC
- Halogen-free according to IEC 61249-2-21 definition

APPLICATIONS

· High speed photo detector

| PRODUCT SUMMARY | | | |
|-----------------|----------------------|---------|-----------------------|
| COMPONENT | I _{ra} (μΑ) | φ (deg) | λ _{0.1} (nm) |
| VBP104S | 35 | ± 65 | 430 to 1100 |
| VBP104SR | 35 | ± 65 | 430 to 1100 |

Note

• Test conditions see table "Basic Characteristics"

| ORDERING INFORMATION | | | | | |
|----------------------|---------------|------------------------------|------------------|--|--|
| ORDERING CODE | PACKAGING | REMARKS | PACKAGE FORM | | |
| VBP104S | Tape and reel | MOQ: 1000 pcs, 1000 pcs/reel | Gullwing | | |
| VBP104SR | Tape and reel | MOQ: 1000 pcs, 1000 pcs/reel | Reverse gullwing | | |

Note

· MOQ: minimum order quantity

| ABSOLUTE MAXIMUM RATINGS (T _{amb} = 25 °C, unless otherwise specified) | | | | | |
|---|-----------------------------------|-------------------|---------------|------|--|
| PARAMETER | TEST CONDITION | SYMBOL | VALUE | UNIT | |
| Reverse voltage | | V _R | 60 | V | |
| Power dissipation | T _{amb} ≤ 25 °C | Pv | 215 | mW | |
| Junction temperature | | Тj | 100 | °C | |
| Operating temperature range | | T _{amb} | - 40 to + 100 | °C | |
| Storage temperature range | | T _{stg} | - 40 to + 100 | °C | |
| Soldering temperature | Acc. reflow solder profile fig. 8 | T _{sd} | 260 | °C | |
| Thermal resistance junction/ambient | | R _{thJA} | 350 | K/W | |

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1 For technical questions, contact: <u>detectortechsupport@vishay.com</u>

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VBP104S and VBP104SR are high speed and high sensitive PIN photodiodes. It is a surface mount device (SMD) including the chip with a 4.4 mm² sensitive area detecting visible and near infrared radiation.

Silicon PIN Photodiode

FEATURES

- Package type: surface mount
- · Package form: GW, RGW
- Dimensions (L x W x H in mm): 6.4 x 3.9 x 1.2
- · Fast response times

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RoHS

COMPLIANT

HALOGEN FREE

Document Number: 81170



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| PARAMETER | TEST CONDITION | SYMBOL | MIN. | TYP. | MAX. | UNIT |
|----------------------------------|---|-------------------|------|-----------------------|------|-------|
| Forward voltage | I _F = 50 mA | VF | | 1 | 1.3 | V |
| Breakdown voltage | I _R = 100 μA, E = 0 | V _(BR) | 60 | | | V |
| Reverse dark current | V _R = 10 V, E = 0 | I _{ro} | | 2 | 30 | nA |
| Diode capacitance | $V_{R} = 0 V, f = 1 MHz, E = 0$ | CD | | 48 | | pF |
| | V _R = 3 V, f = 1 MHz, E = 0 | CD | | 17 | 40 | pF |
| Open circuit voltage | $E_e = 1 \text{ mW/cm}^2$, $\lambda = 950 \text{ nm}$ | Vo | | 350 | | mV |
| Temperature coefficient of Vo | $E_e = 1 \text{ mW/cm}^2$, $\lambda = 950 \text{ nm}$ | TK _{Vo} | | - 2.6 | | mV/K |
| Short circuit current | $E_e = 1 \text{ mW/cm}^2$, $\lambda = 950 \text{ nm}$ | l _k | | 32 | | μA |
| Temperature coefficient of I_k | $E_e = 1 \text{ mW/cm}^2$, $\lambda = 950 \text{ nm}$ | TK _{lk} | | 0.1 | | %/K |
| Reverse light current | $E_e = 1 \text{ mW/cm}^2, \lambda = 950 \text{ nm}, \\ V_R = 5 \text{ V}$ | I _{ra} | 25 | 35 | | μA |
| Angle of half sensitivity | | φ | | ± 65 | | deg |
| Wavelength of peak sensitivity | | λρ | | 940 | | nm |
| Range of spectral bandwidth | | λ _{0.1} | | 430 to 1100 | | nm |
| Noise equivalent power | $V_{R} = 10 \text{ V}, \lambda = 950 \text{ nm}$ | NEP | | 4 x 10 ⁻¹⁴ | | W/√Hz |
| Rise time | $V_{R} = 10 \text{ V}, \text{R}_{\text{L}} = 1 \text{k}\Omega, \\ \lambda = 820 \text{ nm}$ | t _r | | 100 | | ns |
| Fall time | $V_{R} = 10 \text{ V}, \text{ R}_{L} = 1 \text{ k}\Omega,$ $\lambda = 820 \text{ nm}$ | t _f | | 100 | | ns |

BASIC CHARACTERISTICS (T_{amb} = 25 °C, unless otherwise specified)

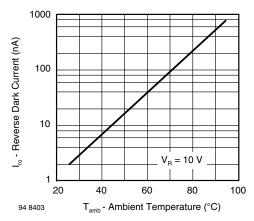


Fig. 1 - Reverse Dark Current vs. Ambient Temperature

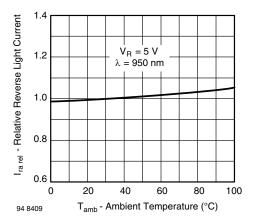


Fig. 2 - Relative Reverse Light Current vs. Ambient Temperature



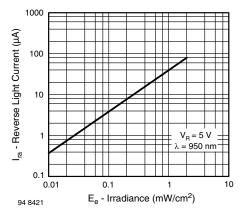


Fig. 3 - Reverse Light Current vs. Irradiance

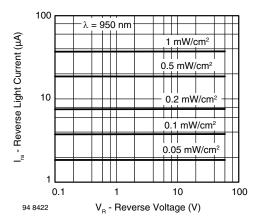


Fig. 4 - Reverse Light Current vs. Reverse Voltage

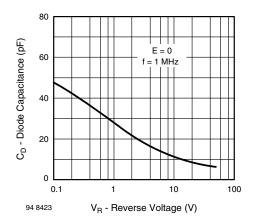


Fig. 5 - Diode Capacitance vs. Reverse Voltage

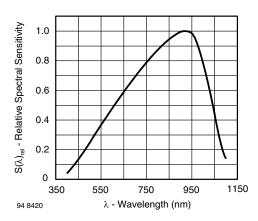


Fig. 6 - Relative Spectral Sensitivity vs. Wavelength

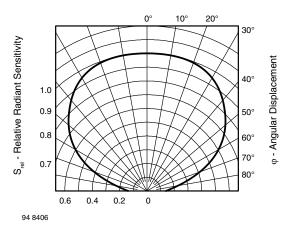


Fig. 7 - Relative Radiant Sensitivity vs. Angular Displacement

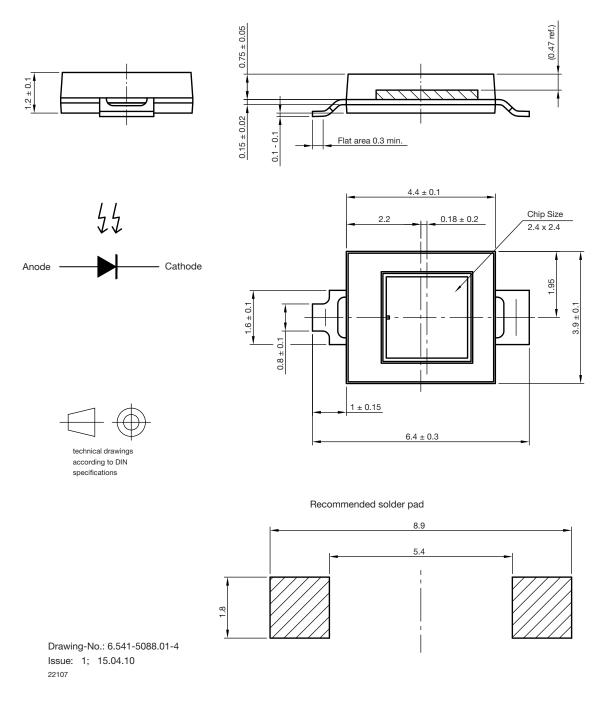
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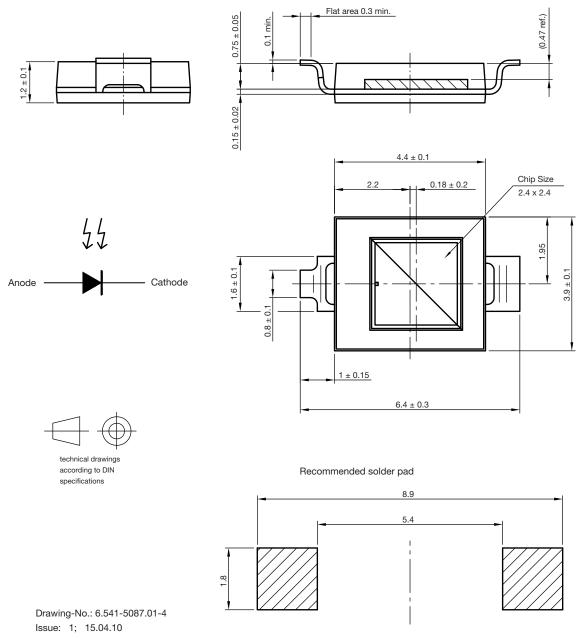
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PACKAGE DIMENSIONS FOR VBP104S in millimeters



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PACKAGE DIMENSIONS FOR VBP104SR in millimeters

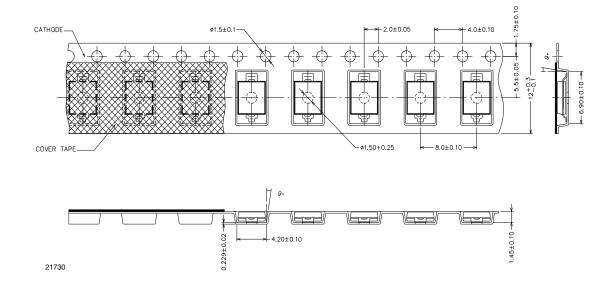


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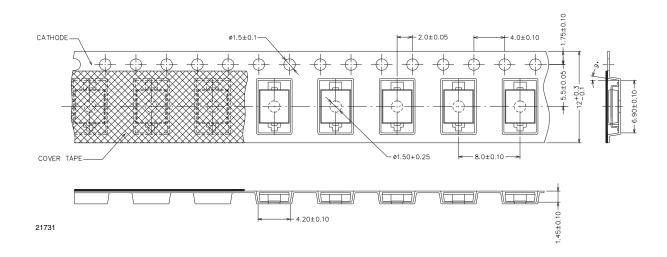
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TAPING DIMENSIONS FOR VBP104S in millimeters



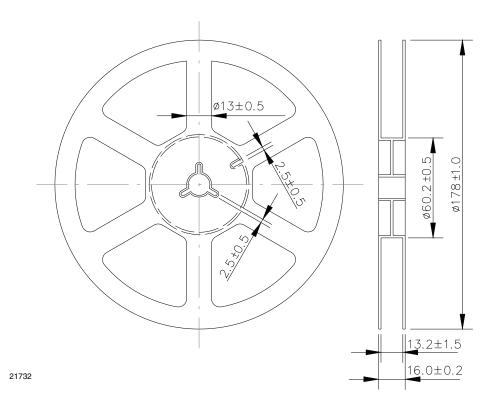
TAPING DIMENSIONS FOR VBP104SR in millimeters



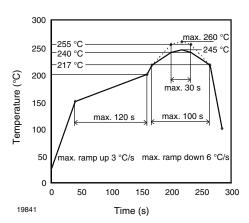
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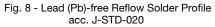


REEL DIMENSIONS FOR VBP104S AND VBP104SR in millimeters



SOLDER PROFILE





DRYPACK

Devices are packed in moisture barrier bags (MBB) to prevent the products from moisture absorption during transportation and storage. Each bag contains a desiccant.

FLOOR LIFE

Time between soldering and removing from MBB must not exceed the time indicated in J-STD-020: Moisture sensitivity: level 3 Floor life: 168 h Conditions: $T_{amb} < 30$ °C, RH < 60 %

DRYING

In case of moisture absorption devices should be baked before soldering. Conditions see J-STD-020 or recommended conditions: 192 h at 40 °C (+ 5 °C), RH < 5 % or 96 h at 60 °C (+ 5 °C), RH < 5 %.

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